L Number	Hits	Search Text	DB	Time stamp
53	49	flexible near pcb and heat near sink	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:29
54	3145	pcb and heat near sink	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:29
55	20	pcb and heat near sink and bonding adj film	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:36
56	0	20030019568.URPN.	USPAT	2004/09/27 15:31
57	5	("4691225" | "5473514" | "5583378" | "5614443" | "5671531").PN.	USPAT	2004/09/27 15:34
58	0	20030019568.URPN.	USPAT	2004/09/27 15:35
59	3145	pcb and heat near sink	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:37
60	2549	pcb and printed adj circuit and heat near sink	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:37
61	2540	pcb and printed adj circuit and heat adj sink	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:37
62	1091	pcb and printed adj circuit and heat adj sink and bonding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:38
63	91	pcb and printed adj circuit and heat adj sink and adhesive near bonding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:44
64	1248	McCutcheon near Jeffrey W. inv.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:43

65	1	McCutcheon near Jeffrey. inv.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:43
66	20	flexible adj printed adj circuit and heat adj sink and adhesive near bonding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 15:57
67	3	flexible adj printed adj circuit and heat adj sink and adhesive near bonding and (174/88R; 174/94R ; 174/259 ; 174/257 ; 174/258 ; 174/254 ; 174/255 ; 174/262 ; 174/264 ; 174/265 ; 174/266 ; 156/150 ; 156/151 ; 156/252 ; 156/277 ; 156/299 ; 156/300 ; 156/306.9 ; 156/307.7 ; 156/309.6 ; 361/749 ; 361/792 ; 29/830 ; 427/97).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 16:01
68	16	("4783695" | "4820781" | "5106667" | "5157589" | "5219640" | "5232548" | "5237205" | "5298331" | "5359496" | "5434751" | "5480841" | "5552222" | "5728473" | "5734008" | "5795162" | "5859181").PN.	USPAT	2004/09/27 15:59
69	13	laminate adj heat near sink and circuit adj board	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 16:11
70	7	("5332695" | "5561321" | "5675474" | "5786633" | "6046907" | "6081426" | "6188579").PN.	USPAT	2004/09/27 16:08
71	1	laminate adj heat near sink and flexible near circuit and heating	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 16:17
72	0	laminate adj heat near sink and pcb and heating	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 16:17
73	59	heat near sink and laminating and pcb and heating	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 16:29

74	19	("3244795" | "4087300" | "4388129" | "4421827" | "4465538" | "4510008" | "4642160" | "4803022" | "4927477" | "5296651" | "5360887" | "5362534" | "5382757" | "5455393" | "5478972" | "5481795" | "5496971" | "5544773" | "5550325").PN.	USPAT	2004/09/27 16:24
75	8	heat near sink and laminating and pcb and heating and 29/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 16:34
76	18	("4012832" | "4075388" | "4242157" | "4436242" | "4664739" | "4818823" | "4936010" | "5072874" | "5137836" | "5146981" | "5182852" | "5253010" | "5268048" | "5451285" | "5471027" | "5601675" | "5616958" | "5632438").PN.	USPAT	2004/09/27 16:31
77	15	("3405323" | "4069498" | "4092697" | "4193445" | "4254431" | "4462462" | "4498119" | "4561011" | "4639829" | "4682269" | "4794981" | "4879632" | "4965699" | "4974119" | "5012858").PN.	USPAT	2004/09/27 16:32
78	140	heat near sink and laminating and (29/830; 29/840 ; 29/841 ; 29/832 ; 438/15 ; 438/119 ; 438/4 ; 257/717 ; 257/700 ; 257/738 ; 257/706 ; 257/701 ; 257/707 ; 257/787 ; 257/796 ; 156/94 ; 156/297).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 16:48
79	8	("4770953" | "5011732" | "5130498" | "5145540" | "5213877" | "5529852" | "5616421" | "5675474").PN.	USPAT	2004/09/27 16:40
80	7	Fraivillig near James .inv.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/27 16:48